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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## SIPMOS® Small-Signal-Transistor

#### **BSO 615NG**

60

0.15

2.6

Ω

#### **Features**

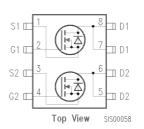
#### **Product Summary**

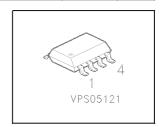
Drain-Source on-state resistance

Drain source voltage

Continuous drain current

- Dual N Channel
- Enhancement mode
- Avalanche rated
- Logic Level
- dv/dt rated
- <sup>6</sup> Pb-free lead plating; RoHS compliant
- ° Qualified according to AEC Q101





 $V_{\overline{\text{DS}}}$ 

 $I_{\rm D}$ 

 $R_{\rm DS(on)}$ 



Туре	Package	Marking
BSO 615N	SO 8	615N

## **Maximum Ratings,** at $T_i = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Continuous drain current, one channel active	I <sub>D</sub>	2.6	Α
Pulsed drain current, one channel active	<i>I</i> Dpulse	10.4	
$T_{A} = 25 ^{\circ}\text{C}$			
Avalanche energy, single pulse	E <sub>AS</sub>	60	mJ
$I_{\rm D}$ = 2.6 A, $V_{\rm DD}$ = 25 V, $R_{\rm GS}$ = 25 $\Omega$			
Avalanche current, periodic limited by $T_{\text{imax}}$	/ <sub>AR</sub>	2.6	А
Avalanche energy, periodic limited by $T_{\text{jmax}}$	E <sub>AR</sub>	0.18	mJ
Reverse diode dv/dt	d <i>v</i> /d <i>t</i>	6	kV/μs
$I_{S} = 2.6 \text{ A}, \ V_{DS} = 40 \text{ V}, \ di/dt = 200 \text{ A/}\mu\text{s},$			
$T_{\text{jmax}} = 150 ^{\circ}\text{C}$			
Gate source voltage	$V_{\rm GS}$	±20	V
Power dissipation, one channel active	P <sub>tot</sub>	2	W
$T_{A} = 25  ^{\circ}\text{C}$			
Operating temperature	$T_{i}$	-55 <b>+</b> 150	°C
Storage temperature	$T_{\rm stg}$	-55 <b>+</b> 150	
IEC climatic category; DIN IEC 68-1		55/150/56	



#### **Thermal Characteristics**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics				•	•
Thermal resistance, junction - soldering point	R <sub>thJS</sub>	-	-	35	K/W
Thermal resistance @ 10 sec., min. footprint	R <sub>th(JA)</sub>	-	-	100	
Thermal resistance @ 10 sec.,	$R_{\rm th(JA)}$	-	-	62.5	
6 cm <sup>2</sup> cooling area <sup>1)</sup>					

# **Electrical Characteristics,** at $T_i$ = 25 °C, unless otherwise specified

Parameter	Symbol	Symbol Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain- source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V
$V_{GS} = 0 \text{ V}, I_D = 0.25 \text{ mA}$	, ,				
Gate threshold voltage, $V_{GS} = V_{DS}$	V <sub>GS(th)</sub>	1.2	1.6	2	
$I_{\rm D} = 20 \; \mu {\rm A}$	, ,				
Zero gate voltage drain current	l <sub>DSS</sub>				μΑ
$V_{DS} = 60 \text{ V}, \ V_{GS} = 0 \text{ V}, \ T_j = 25 \text{ °C}$		-	0.1	1	
$V_{DS} = 60 \text{ V}, \ V_{GS} = 0 \text{ V}, \ T_j = 150 \text{ °C}$		-	10	100	
Gate-source leakage current	l <sub>GSS</sub>	-	10	100	nA
$V_{GS} = 20 \text{ V}, \ V_{DS} = 0 \text{ V}$					
Drain-Source on-state resistance	R <sub>DS(on)</sub>				Ω
$V_{\rm GS} = 4.5 \text{ V}, I_{\rm D} = 2.6 \text{ A}$		-	0.12	0.15	

<sup>&</sup>lt;sup>1</sup> Device on 40mm\*40mm\*1.5mm epoxy PCB FR4 with 6 cm2 (one layer, 70μm thick) copper area for drain connection. PCB is vertical without blown air.



## **Electrical Characteristics**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics		•			•
Transconductance	9 <sub>fs</sub>	2.4	5.5	-	S
$V_{\text{DS}} \ge 2^* I_{\text{D}}^* R_{\text{DS(on)max}}$ , $I_{\text{D}} = 2.6 \text{ A}$					
Input capacitance	C <sub>iss</sub>	-	300	380	рF
$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$					
Output capacitance	$C_{\text{oss}}$	-	90	120	
$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$					
Reverse transfer capacitance	$C_{rss}$	-	50	65	
$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$					
Turn-on delay time	$t_{d(on)}$	-	12	20	ns
$V_{DD} = 30 \text{ V}, \ V_{GS} = 4.5 \text{ V}, \ I_{D} = 2.6 \text{ A},$					
$R_{\rm G}$ = 16 $\Omega$					
Rise time	$t_{r}$	-	15	25	
$V_{\text{DD}} = 30 \text{ V}, \ V_{\text{GS}} = 4.5 \text{ V}, \ I_{\text{D}} = 2.6 \text{ A},$					
$R_{\rm G}$ = 16 $\Omega$					
Turn-off delay time	$t_{\rm d(off)}$	-	20	30	
$V_{\text{DD}} = 30 \text{ V}, \ V_{\text{GS}} = 4.5 \text{ V}, \ I_{\text{D}} = 2.6 \text{ A},$					
$R_{\rm G}$ = 16 $\Omega$					
Fall time	t <sub>f</sub>	-	15	25	
$V_{\rm DD}$ = 30 V, $V_{\rm GS}$ = 4.5 V, $I_{\rm D}$ = 2.6 A,					
$R_{\rm G}$ = 16 $\Omega$					



## **Electrical Characteristics,** at $T_i = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit	
at $T_i = 25$ °C, unless otherwise specified		min.	typ.	max.		
Dynamic Characteristics						
Gate charge at threshold	Q <sub>G(th)</sub>	-	0.4	0.6	nC	
$V_{\rm DD}$ = 40 V, $I_{\rm D}$ = 0.1 A, $V_{\rm GS}$ = 1 V						
Gate charge at V <sub>qs</sub> =5V	Q <sub>g(5)</sub>	-	7	10		
$V_{\rm DD}$ = 40 V, $I_{\rm D}$ = 2.6 A, $V_{\rm GS}$ = 0 to 5 V	9(5)					
Gate charge total	$Q_{a}$	-	14	20	nC	
$V_{\rm DD}$ = 40 V, $I_{\rm D}$ = 2.6 A, $V_{\rm GS}$ = 0 to 10 V						
Gate plateau voltage	V <sub>(plateau)</sub>	-	3.6	-	٧	
$V_{\rm DD}$ = 40 V, $I_{\rm D}$ = 2.6 A	(,2.33.2.3.2)					

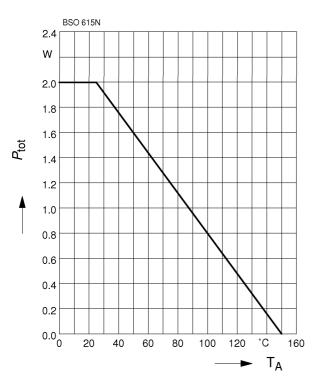
### **Reverse Diode**

Inverse diode continuous forward current	Is	-	-	2.6	Α
<i>T</i> <sub>A</sub> = 25 °C					
Inverse diode direct current,pulsed	/ <sub>SM</sub>	-	-	10.4	
<i>T</i> <sub>A</sub> = 25 °C					
Inverse diode forward voltage	$V_{\mathrm{SD}}$	-	0.95	1.2	V
$V_{\rm GS} = 0 \text{ V}, I_{\rm F} = 5.2 \text{ A}$					
Reverse recovery time	t <sub>rr</sub>	-	50	75	ns
$V_{R} = 30 \text{ V}, I_{F} = I_{S}, di_{F}/dt = 100 \text{ A/}\mu\text{s}$					
Reverse recovery charge	Q <sub>rr</sub>	-	0.1	0.15	μC
$V_{R} = 30 \text{ V}, I_{F} = I_{S}, dI_{F}/dt = 100 \text{ A/}\mu\text{s}$					



### **Power Dissipation**

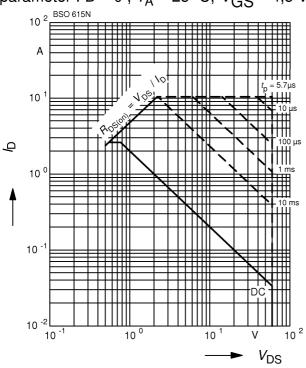
$$P_{\text{tot}} = f(T_{A}), V_{GS} = 4.5 \text{ V}$$



## Safe operating area

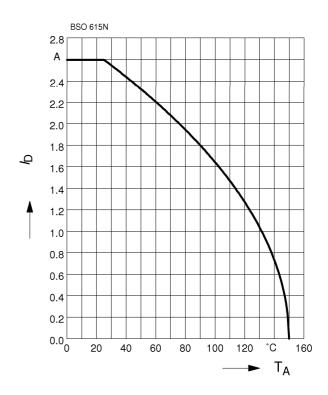
$$I_{\mathsf{D}} = f(V_{\mathsf{DS}})$$

parameter : 
$$D = 0$$
 ,  $T_A = 25$  °C,  $V_{GS} = 4.5$  V



#### **Drain current**

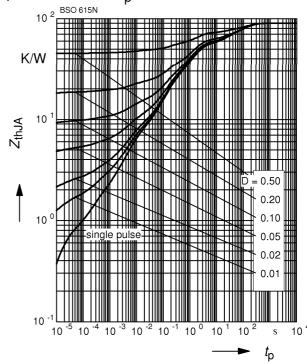
$$I_{D} = f(T_{A}), \ V_{GS} = 4.5 \ V$$



#### **Transient thermal impedance**

$$Z_{\text{thJA}} = f(t_{p})$$

parameter : 
$$D = t_D/T$$

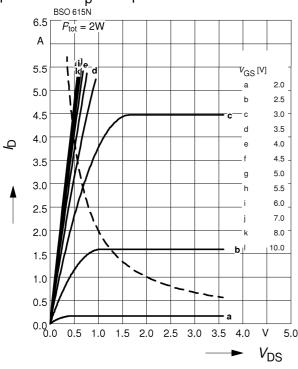




### Typ. output characteristics

 $I_{\mathsf{D}} = f\left(V_{\mathsf{DS}}\right)$ 

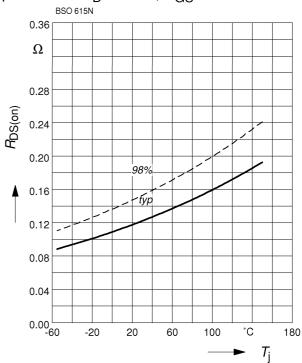
parameter:  $t_p = 80 \mu s$ 



#### **Drain-source on-resistance**

 $R_{DS(on)} = f(T_j)$ 

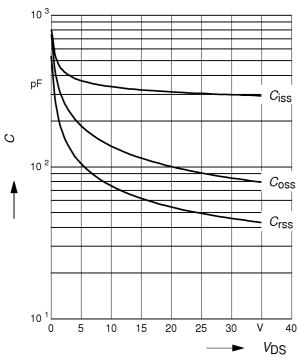
parameter :  $I_D = 2.6 \text{ A}, V_{GS} = 4.5 \text{ V}$ 



## Typ. capacitances

 $C = f(V_{DS})$ 

parameter:  $V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ 

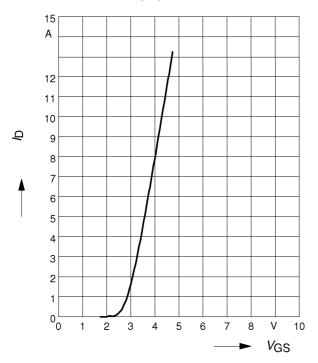




## Typ. transfer characteristics $I_{D}$ = $f(V_{GS})$

parameter:  $t_p = 80 \mu s$ 

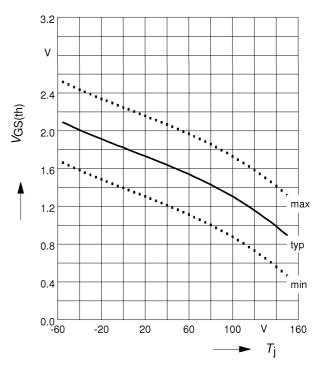
 $V_{DS} \ge 2 \times I_D \times R_{DS(on) \text{ max}}$ 



### Gate threshold voltage

 $V_{GS(th)} = f(T_j)$ 

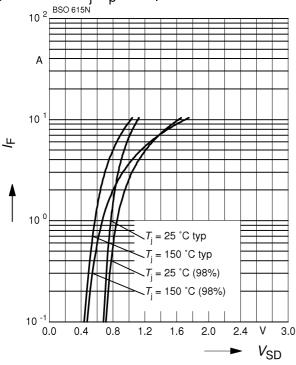
parameter :  $V_{GS} = V_{DS}$ ,  $I_D = 20 \mu A$ 



#### Forward characteristics of reverse diode

$$I_{\mathsf{F}} = f(V_{\mathsf{SD}})$$

parameter:  $T_j$ ,  $t_p = 80 \mu s$ 

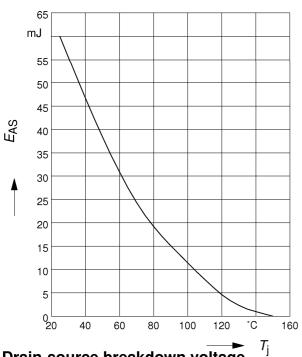




## Avalanche Energy $E_{AS} = f(T_i)$

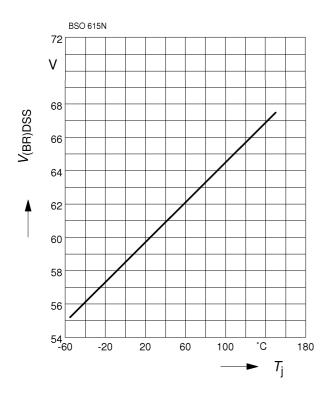
parameter:  $I_D = 2.6 \text{ A}, V_{DD} = 25 \text{ V}$ 

$$R_{\rm GS} = 25~\Omega$$



## Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$



## Typ. gate charge

$$V_{\rm GS} = f(Q_{\rm Gate})$$

parameter:  $I_{D \text{ puls}} = 2.6 \text{ A}$ 

